

Title: Flip Chip Adaptor Package for Bare Die
Inventor: Walter L. Moden

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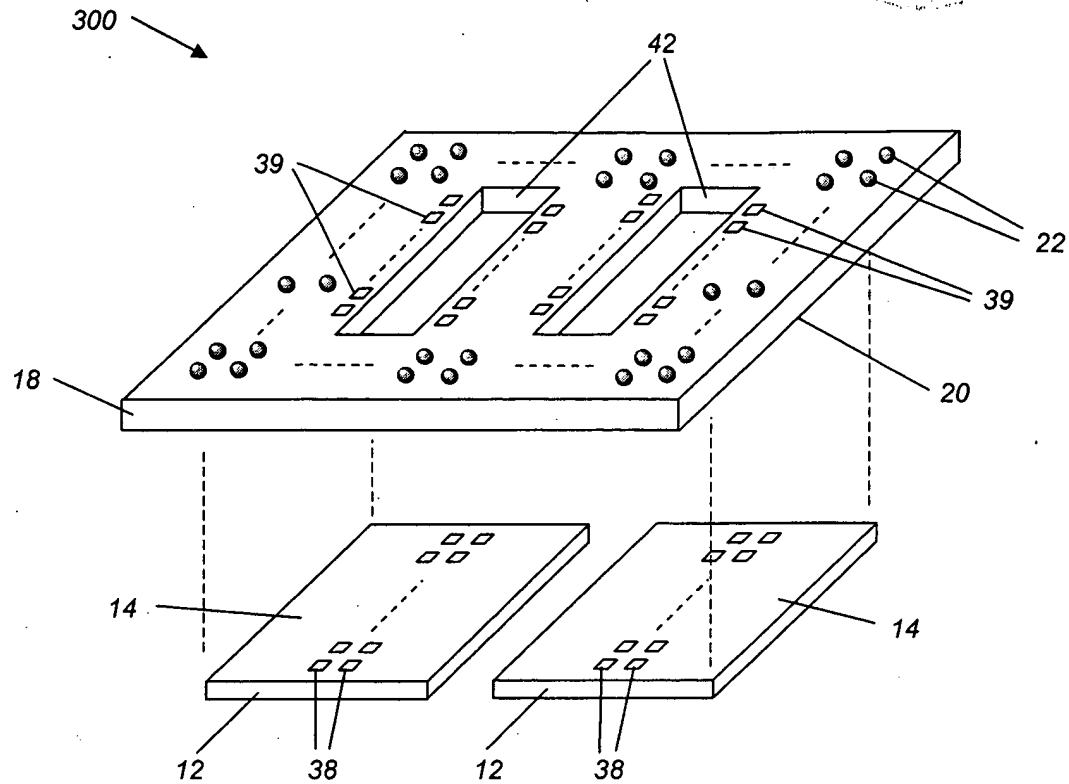


Fig. 3A